

	Typ	L #	Hits	Search T xt	DBs	Time Stamp
1	IS&R	L1	1626	(438/128).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/07/15 10:45
2	BRS	L2	89	1 and (bond\$4 near2 pad\$3)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/07/15 10:52
3	IS&R	L3	648	(438/129).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/07/15 10:53
4	BRS	L4	48	3 and (bond\$4 near2 pad\$3)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/07/15 12:41
5	BRS	L5	2388	(wire near2 bond) near8 (bond near2 pad)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/07/15 12:42

	Typ	L #	Hits	Search Text	DBs	Time Stamp
6	BRS	L6	0	5 same (ball or balls or solder or epoxy or soldering) same (screen near2 printing)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/07/15 12:42
7	BRS	L7	556	5 same (ball or balls or solder or epoxy or soldering)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/07/15 12:43
8	BRS	L8	54	7 and (screen near2 print\$4)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/07/15 12:43

	Typ	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L1	29	"wire bond" same "screen printing"	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/07/15 14:35